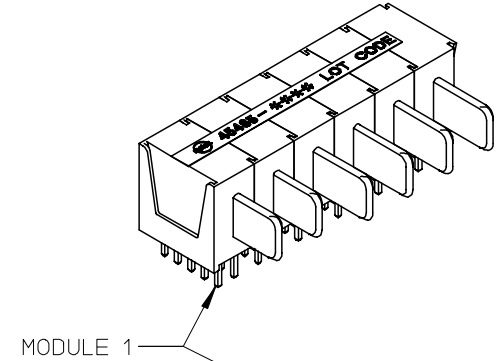
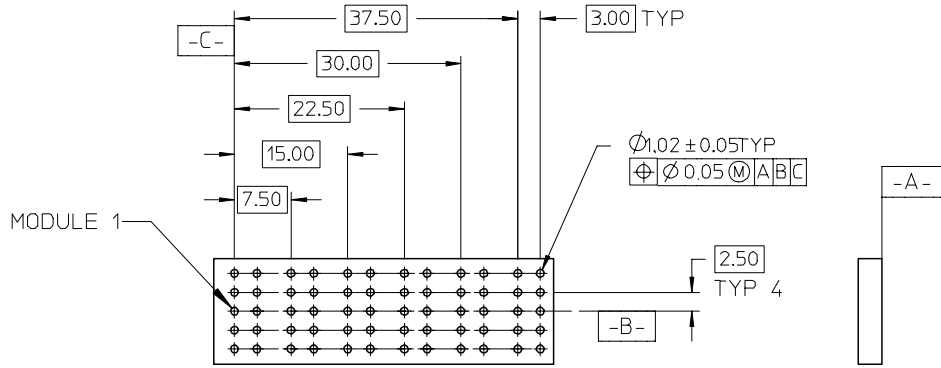
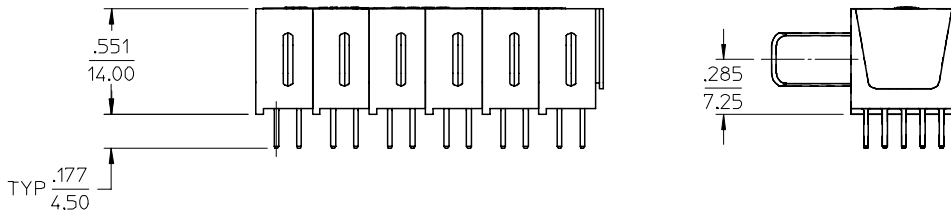
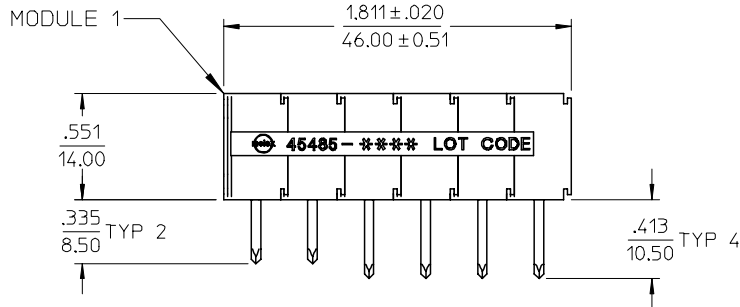


NOTES:

1. MATERIAL: LCP, GLASS FILLED, UL94V-0, BLACK.  
CONTACTS: COPPER ALLOY
2. FINISH: SELECT GOLD: 30 MI MIN.  
SELECT TIN: 100 MI MIN.  
BOTH OVER NICKEL
3. PRODUCT SPECIFICATION: PS-45424-001.
4. PACKAGING SPECIFICATION: PK-45485-001.



PD	PD	PD	PD	PD	PD
107	107	105	105	105	105

PCB LAYOUT: COMPONENT SIDE  
PCB THICKNESS: .125/3.18  
PCB TOLERANCE: ±.002/0.05

EC NO: UCP2005-2491	DESCRIPTION
DRWN: ADRAIND2005/07/07	
CHKD: SAMEC 2005/07/08	
APPR: APATEL 2005/07/19	
A1	REV

GENERAL TOLERANCES (UNLESS SPECIFIED)	
	mm INCH
4 PLACES	± --- ± ---
3 PLACES	± --- ± .010
2 PLACES	± 0.25 ± .015
1 PLACE	± 0.38 ± ---
ANGULAR ±1/2°	
DRAFT WHERE APPLICABLE	
MUST REMAIN WITHIN DIMENSIONS	

SCALE	DESIGN UNITS
1:1	METRIC
DIMENSION STYLE	
IN/MM	
DRAWN BY	DATE
JSCHAFFER	2004/07/30
CHECKED BY	DATE
KSAMIEC	2004/07/30
APPROVED BY	DATE
MARGULIS	2004/08/02

THIRD ANGLE PROJECTION	REVISE ON CAD ONLY	
TITLE	POWER DOCK ASSEMBLY POWER RIGHT ANGLE SOLDER TAIL	
Molex	MOLEX INCORPORATED	
MATERIAL NO.	DOCUMENT NO.	SHEET NO.
454850167	SD-45485-167	1 OF 1
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